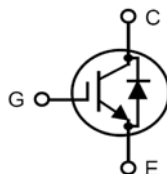


900V XPT™ IGBT GenX3™ w/ Diode

IXYA8N90C3D1 IXYP8N90C3D1

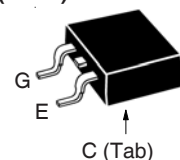
$V_{CES} = 900V$
 $I_{C110} = 8A$
 $V_{CE(sat)} \leq 3.0V$
 $t_{fi(typ)} = 130ns$

High-Speed IGBT
for 20-50 kHz Switching

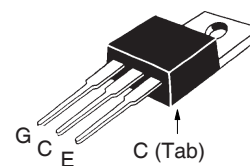


| Symbol | Test Conditions | Maximum Ratings | |
|-------------------------------|--|--|------------|
| V_{CES} | $T_J = 25^\circ C$ to $175^\circ C$ | 900 | V |
| V_{CGR} | $T_J = 25^\circ C$ to $175^\circ C$, $R_{GE} = 1M\Omega$ | 900 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ C$ | 20 | A |
| I_{C110} | $T_C = 110^\circ C$ | 8 | A |
| I_{F110} | $T_C = 110^\circ C$ | 12 | A |
| I_{CM} | $T_C = 25^\circ C$, 1ms | 48 | A |
| I_A | $T_C = 25^\circ C$ | 4 | A |
| E_{AS} | $T_C = 25^\circ C$ | 15 | mJ |
| SSOA (RBSOA) | $V_{GE} = 15V$, $T_{VJ} = 150^\circ C$, $R_G = 30\Omega$ Clamped Inductive Load | $I_{CM} = 16$ @ $V_{CE} \leq V_{CES}$ | A |
| P_C | $T_C = 25^\circ C$ | 125 | W |
| T_J | | -55 ... +175 | $^\circ C$ |
| T_{JM} | | 175 | $^\circ C$ |
| T_{stg} | | -55 ... +175 | $^\circ C$ |
| T_L | Maximum Lead Temperature for Soldering | 300 | $^\circ C$ |
| T_{SOLD} | 1.6 mm (0.062in.) from Case for 10s | 260 | $^\circ C$ |
| M_d | Mounting Torque (TO-220) | 1.13/10 | Nm/lb.in. |
| F_C | Mounting Force (TO-263) | 10..65 / 2.2..14.6 | N/lb. |
| Weight | TO-263 | 2.5 | g |
| | TO-220 | 3.0 | g |

TO-263 AA (IXYA)



TO-220AB (IXYP)



G = Gate C = Collector
 E = Emitter Tab = Collector

Features

- Optimized for Low Switching Losses
- Square RBSOA
- Positive Thermal Coefficient of $V_{ce(sat)}$
- Anti-Parallel Ultra Fast Diode
- Avalanche Rated
- International Standard Packages

Advantages

- High Power Density
- Low Gate Drive Requirement

Applications

- High Frequency Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

| Symbol | Test Conditions ($T_J = 25^\circ C$, Unless Otherwise Specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|---------------------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 250\mu A$, $V_{GE} = 0V$ | 950 | | V |
| $V_{GE(th)}$ | $I_C = 250\mu A$, $V_{CE} = V_{GE}$ | 3.5 | | 6.0 V |
| I_{CES} | $V_{CE} = V_{CES}$, $V_{GE} = 0V$ $T_J = 125^\circ C$ | | | 60 μA 400 μA |
| I_{GES} | $V_{CE} = 0V$, $V_{GE} = \pm 20V$ | | | ± 100 nA |
| $V_{CE(sat)}$ | $I_C = 8A$, $V_{GE} = 15V$, Note 1 $T_J = 125^\circ C$ | 2.15 2.60 | | 3.00 V V |

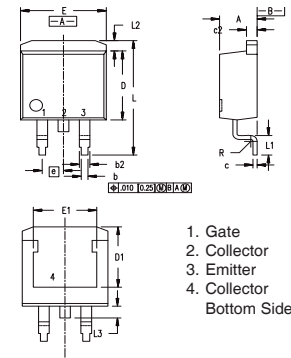
| Symbol Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified) | | Characteristic Values | | |
|--|---|-----------------------|------|------------------------|
| | | Min. | Typ. | Max. |
| g_{fs} | $I_C = 8\text{A}, V_{CE} = 10\text{V}, \text{Note 1}$ | 2.9 | 4.8 | S |
| C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | | 400 | pF |
| C_{oes} | | | 30 | pF |
| C_{res} | | | 7.8 | pF |
| $Q_{g(on)}$ | $I_C = 8\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$ | | 13.3 | nC |
| Q_{ge} | | | 3.4 | nC |
| Q_{gc} | | | 5.8 | nC |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ $I_C = 8\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 30\Omega$ Note 2 | | 16 | ns |
| t_{ri} | | | 20 | ns |
| E_{on} | | | 0.46 | mJ |
| $t_{d(off)}$ | | | 40 | ns |
| t_{fi} | | | 130 | ns |
| E_{off} | | 0.18 | 0.50 | mJ |
| $t_{d(on)}$ | Inductive load, $T_J = 125^\circ\text{C}$ $I_C = 8\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 30\Omega$ Note 2 | | 17 | ns |
| t_{ri} | | | 22 | ns |
| E_{on} | | | 1.00 | mJ |
| $t_{d(off)}$ | | | 75 | ns |
| t_{fi} | | | 163 | ns |
| E_{off} | | 0.22 | mJ | |
| R_{thJC} | TO-220 | | | 1.2 $^\circ\text{C/W}$ |
| R_{thCS} | | | 0.50 | $^\circ\text{C/W}$ |

Reverse Diode (FRED)

| Symbol Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | | Characteristic Value | | |
|--|---|--|------|------------------------|
| | | Min. | Typ. | Max. |
| V_F | $I_F = 10\text{A}, V_{GE} = 0\text{V}, \text{Note 1}$ | | | 3.0 V |
| | $T_J = 150^\circ\text{C}$ | | | 2.0 V |
| I_{RM} | $I_F = 10\text{A}, V_{GE} = 0\text{V}, -di_F/dt = 200\text{A}/\mu\text{s}, T_J = 100^\circ\text{C}$ | | 7.5 | A |
| t_{rr} | | $V_R = 600\text{V}, T_J = 100^\circ\text{C}$ | | 114 |
| R_{thJC} | | | | 2.5 $^\circ\text{C/W}$ |

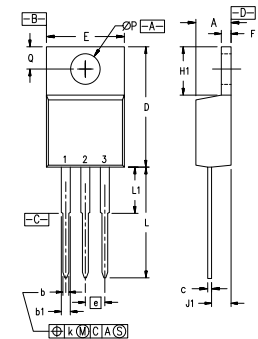
Notes:

- Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.
- Switching times & energy losses may increase for higher V_{CE} (clamp), T_J or R_G .

TO-263 Outline


- Gate
 - Collector
 - Emitter
 - Collector
- Bottom Side

| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|------|
| | Min. | Max. | Min. | Max. |
| A | 4.06 | 4.83 | .160 | .190 |
| b | 0.51 | 0.99 | .020 | .039 |
| b2 | 1.14 | 1.40 | .045 | .055 |
| c | 0.40 | 0.74 | .016 | .029 |
| c2 | 1.14 | 1.40 | .045 | .055 |
| D | 8.64 | 9.65 | .340 | .380 |
| D1 | 8.00 | 8.89 | .280 | .320 |
| E | 9.65 | 10.41 | .380 | .405 |
| E1 | 6.22 | 8.13 | .270 | .320 |
| e | 2.54 | BSC | .100 | BSC |
| L | 14.61 | 15.88 | .575 | .625 |
| L1 | 2.29 | 2.79 | .090 | .110 |
| L2 | 1.02 | 1.40 | .040 | .055 |
| L3 | 1.27 | 1.78 | .050 | .070 |
| L4 | 0 | 0.13 | 0 | .005 |

TO-220 Outline


- Pins: 1 - Gate 2 - Collector
3 - Emitter

| SYM | INCHES | | MILLIMETERS | |
|-----|--------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .170 | .190 | 4.32 | 4.83 |
| b | .025 | .040 | 0.64 | 1.02 |
| b1 | .045 | .065 | 1.15 | 1.65 |
| c | .014 | .022 | 0.35 | 0.56 |
| D | .580 | .630 | 14.73 | 16.00 |
| E | .390 | .420 | 9.91 | 10.66 |
| e | .100 | BSC | 2.54 | BSC |
| F | .045 | .055 | 1.14 | 1.40 |
| H1 | .230 | .270 | 5.85 | 6.85 |
| J1 | .090 | .110 | 2.29 | 2.79 |
| k | 0 | .015 | 0 | 0.38 |
| L | .500 | .550 | 12.70 | 13.97 |
| L1 | .110 | .230 | 2.79 | 5.84 |
| ØP | .139 | .161 | 3.53 | 4.08 |
| Q | .100 | .125 | 2.54 | 3.18 |

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

| | | | | | | | | | | |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| | 4,860,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 | |
| | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 | |

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

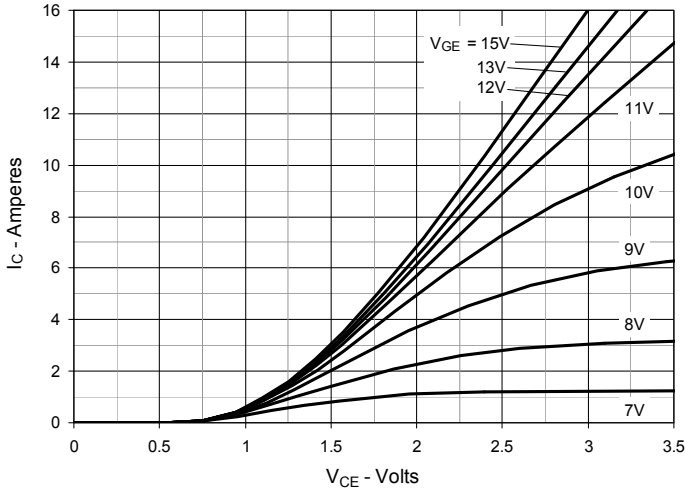


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

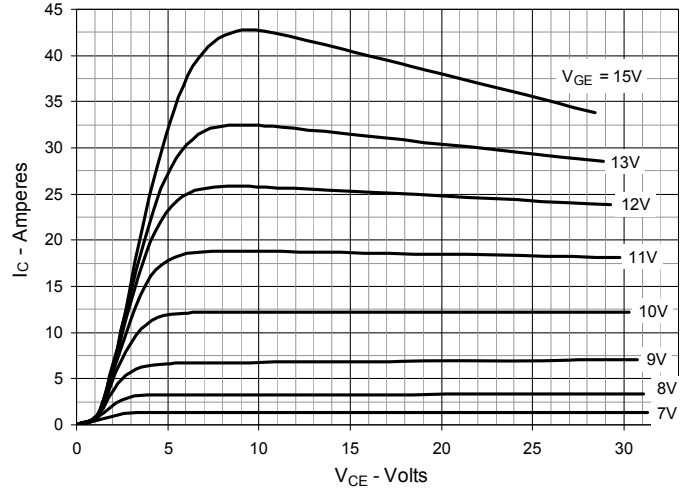


Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

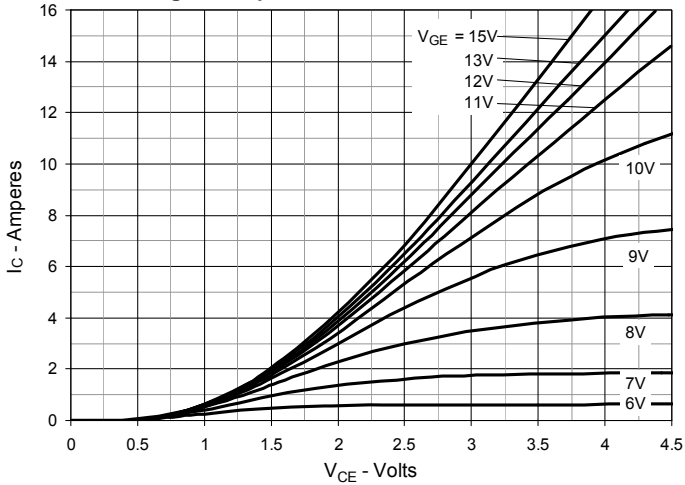


Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

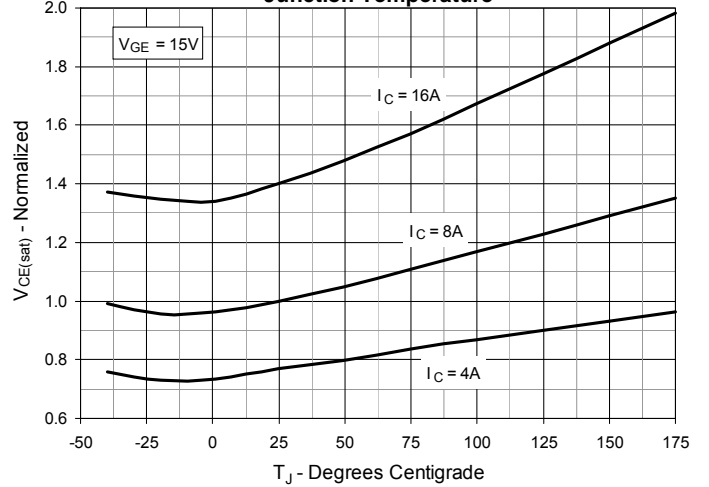


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

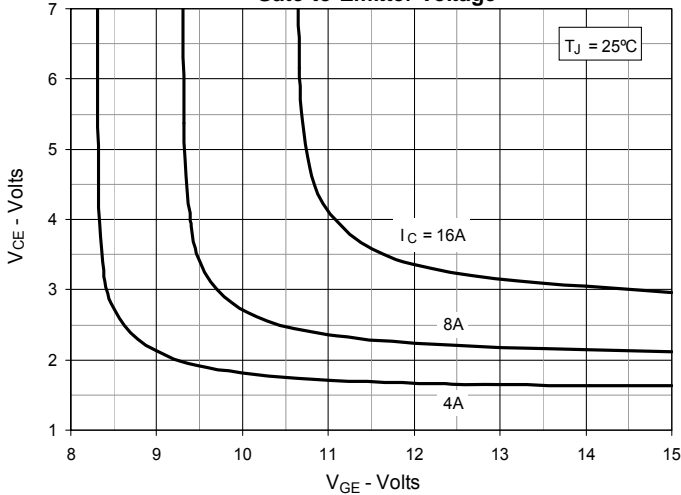


Fig. 6. Input Admittance

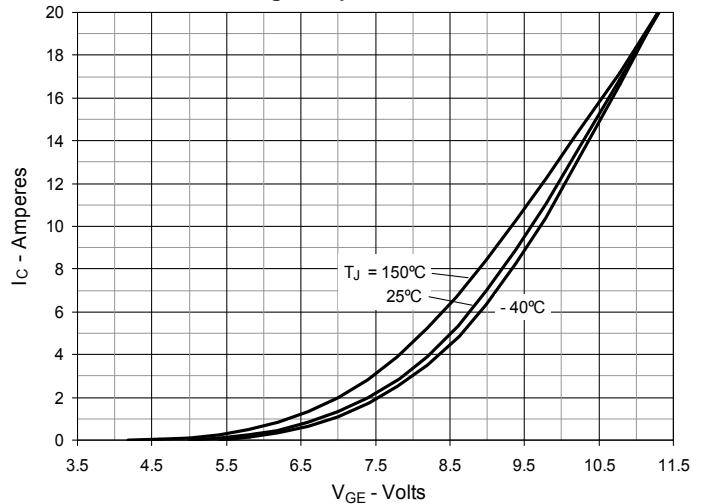


Fig. 7. Transconductance

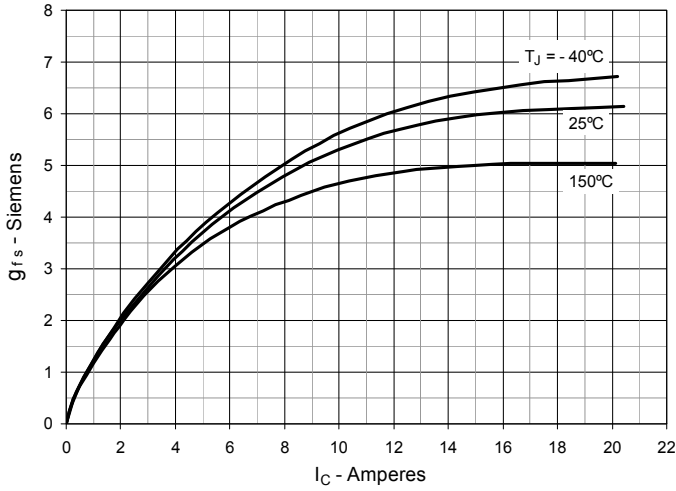


Fig. 8. Gate Charge

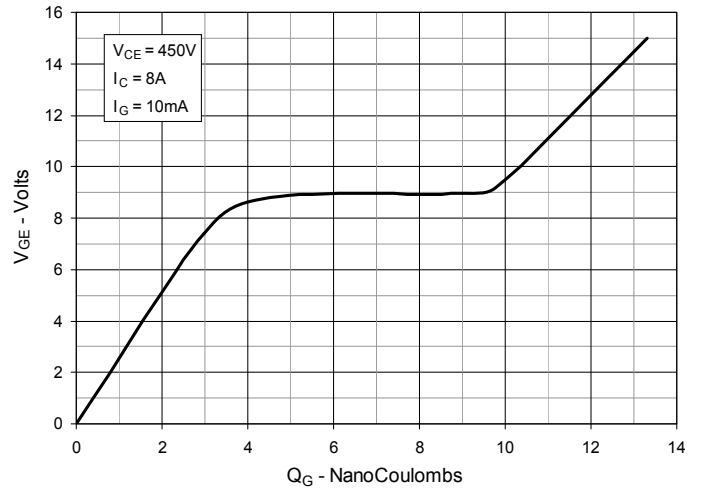


Fig. 9. Capacitance

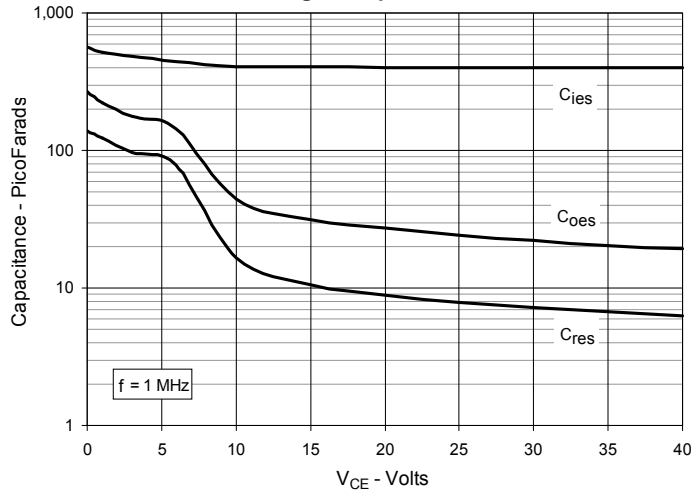


Fig. 10. Reverse-Bias Safe Operating Area

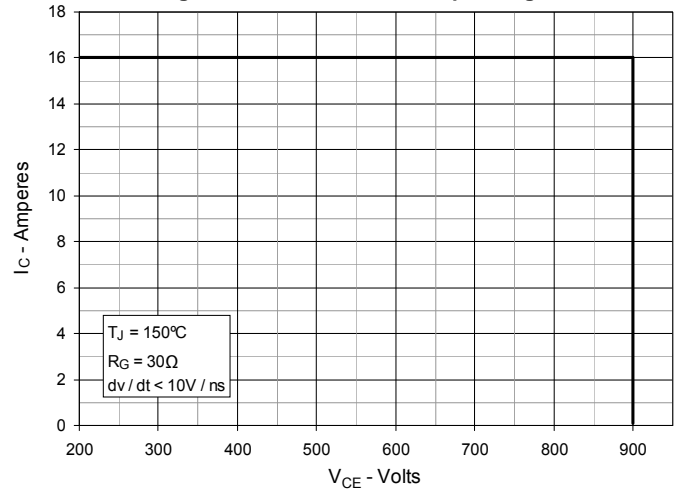


Fig. 11. Maximum Transient Thermal Impedance

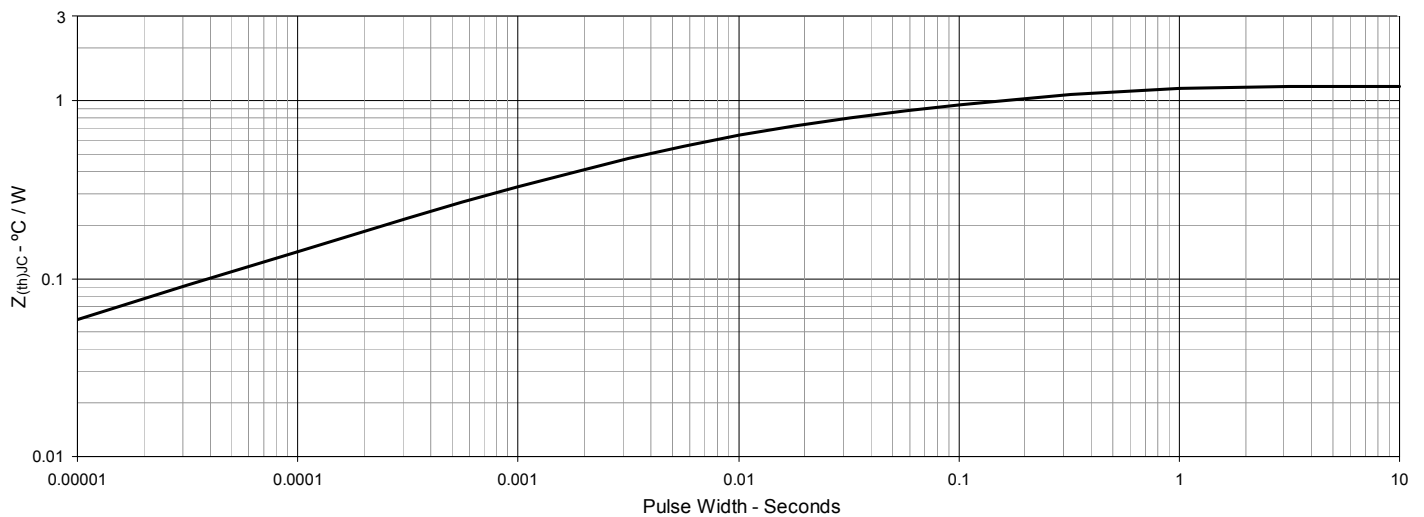


Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance

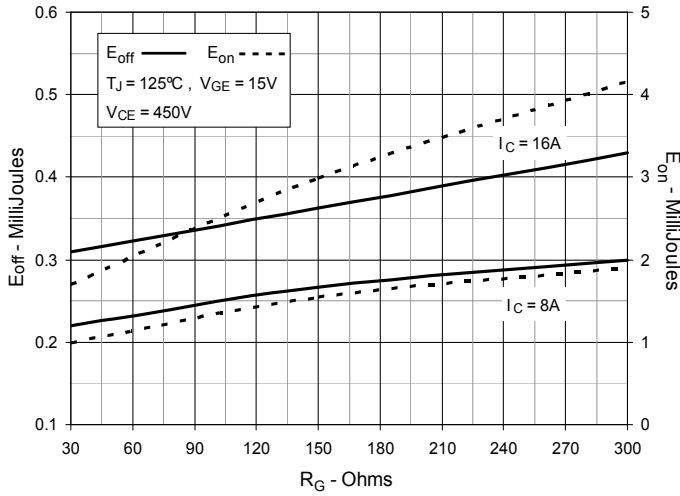


Fig. 13. Inductive Switching Energy Loss vs. Collector Current

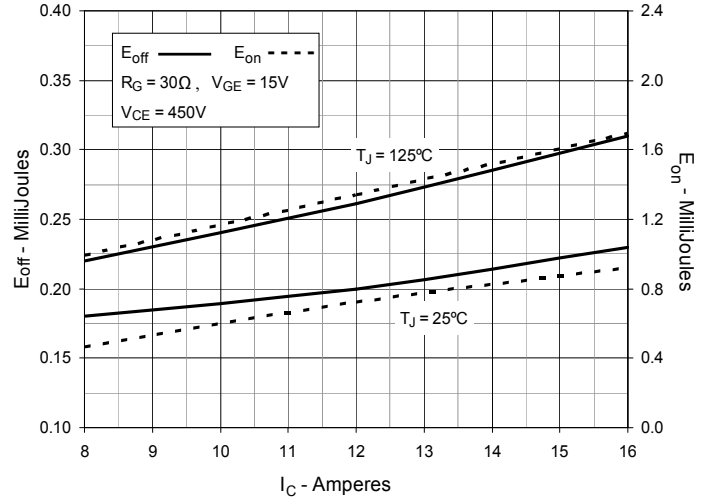


Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature

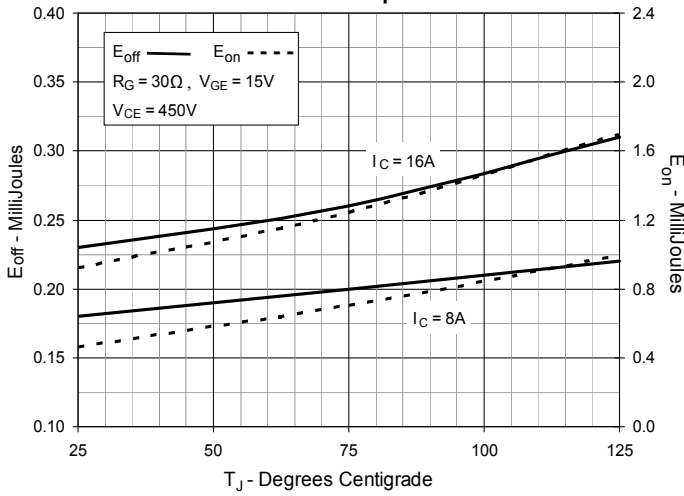


Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance

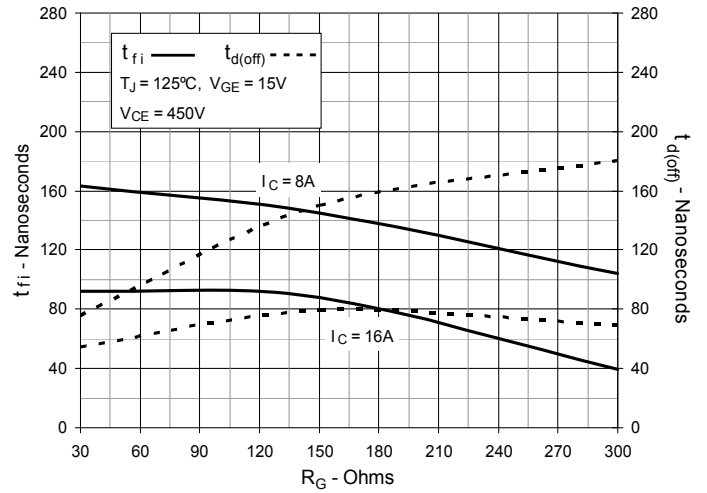


Fig. 16. Inductive Turn-off Switching Times vs. Collector Current

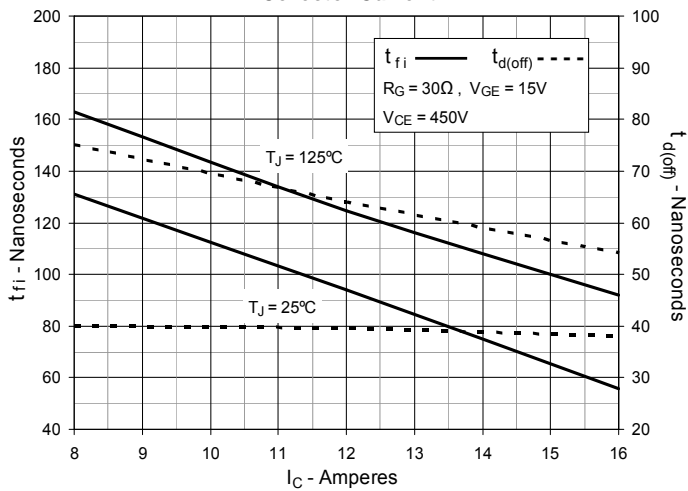


Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature

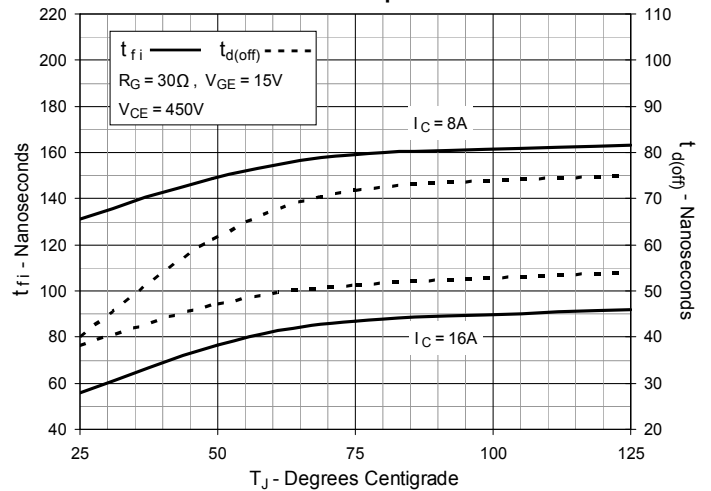


Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance

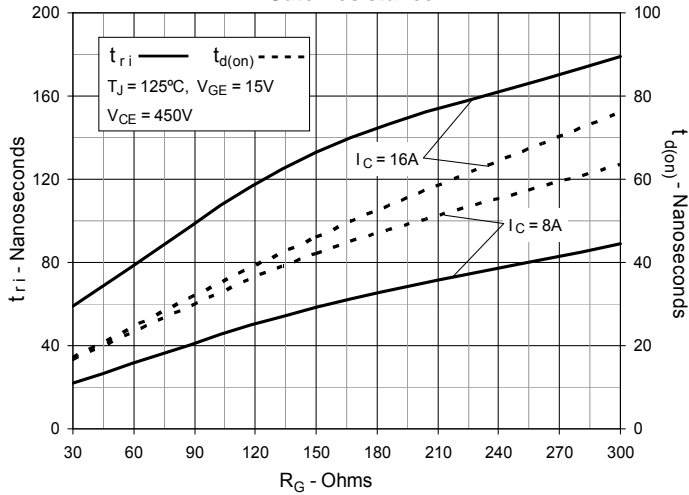


Fig. 19. Inductive Turn-on Switching Times vs. Collector Current

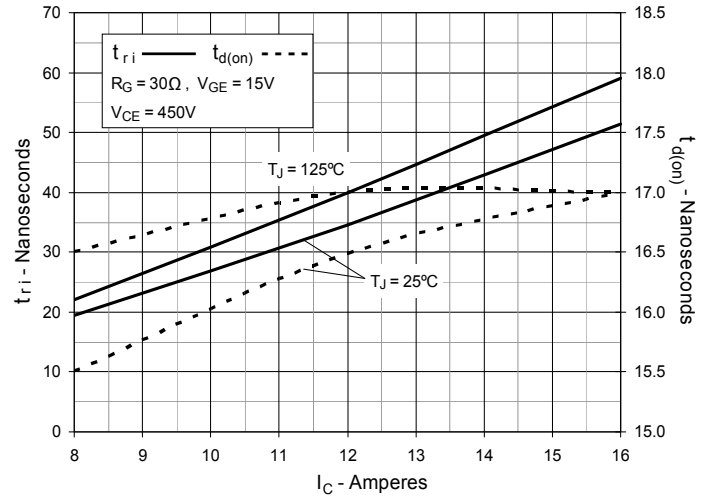
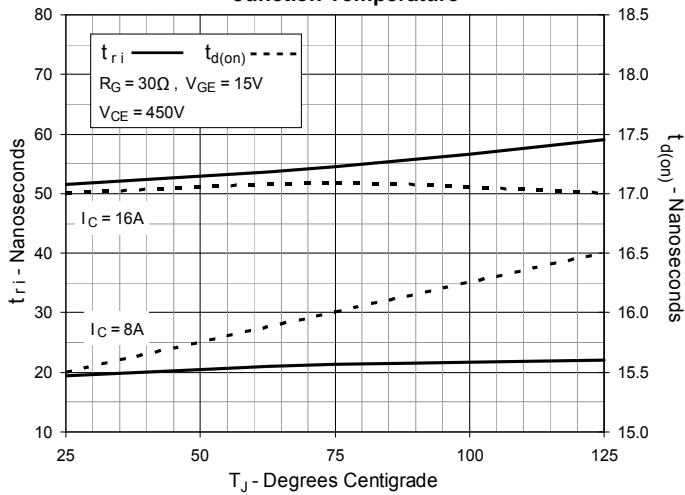


Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature



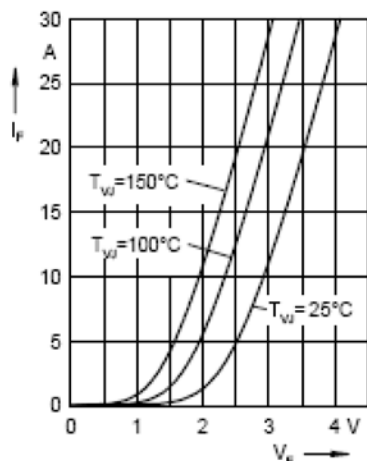


Fig. 21. Forward current I_F vs V_F

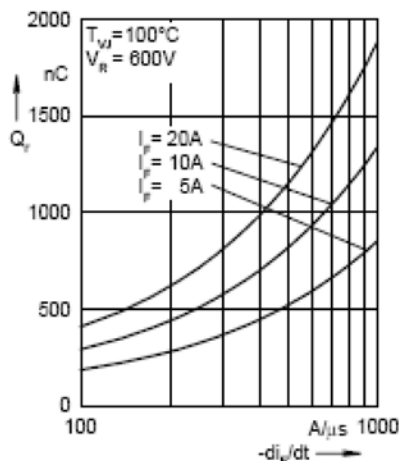


Fig. 22. Reverse recovery charge Q_r versus $-di_F/dt$

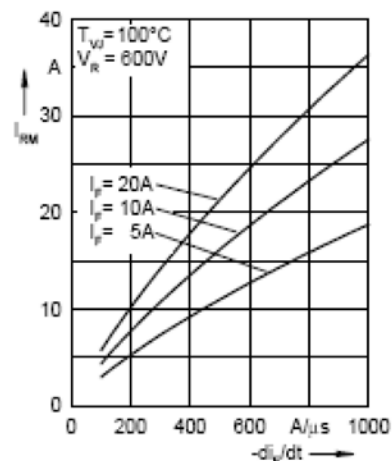


Fig. 23. Peak reverse current I_{RM} versus $-di_F/dt$

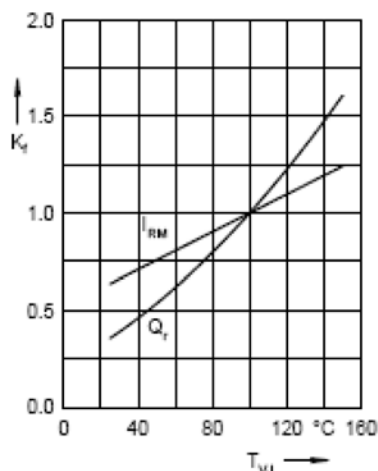


Fig. 24. Dynamic parameters Q_r , I_{RM} versus T_{WJ}

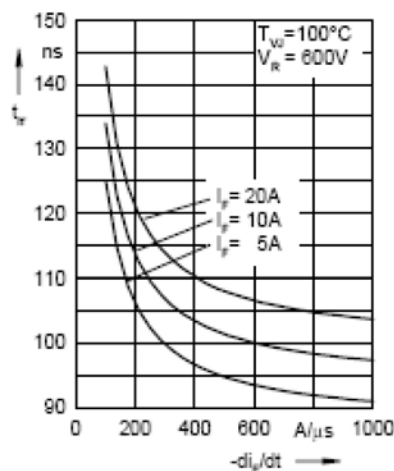


Fig. 25. Recovery time t_r versus $-di_F/dt$

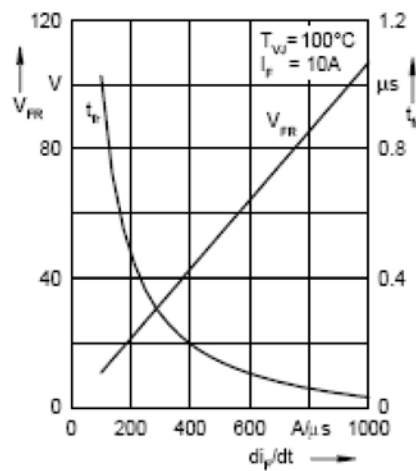


Fig. 26. Peak forward voltage V_{FR} and t_r versus di_F/dt

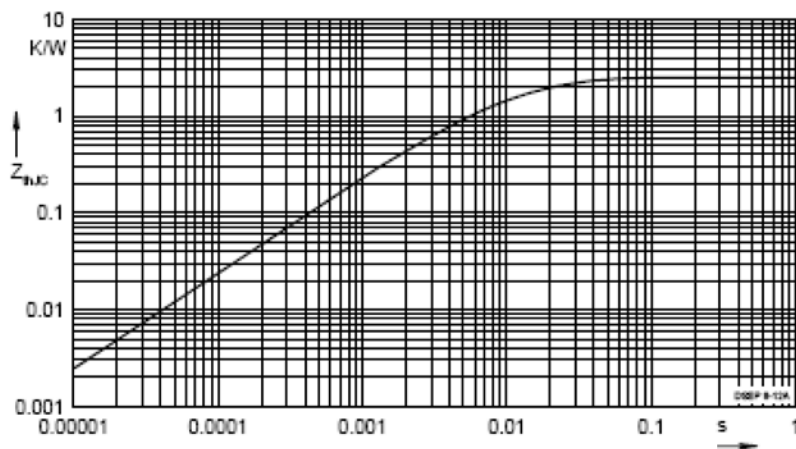


Fig. 27. Transient thermal resistance junction to case



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